



**THE DATASHEET OF  
LQA30B200C**



# LQA30T200C, LQA30B200C

## Qspeed™ Family

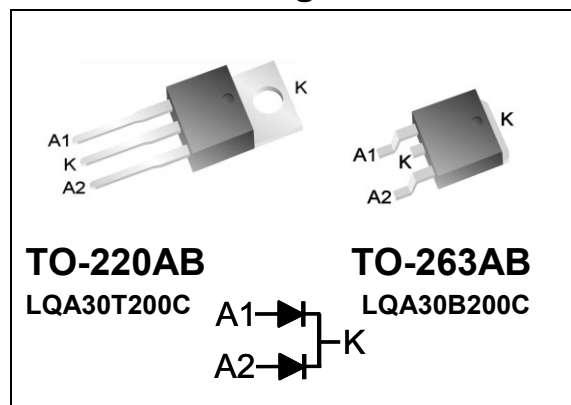


200 V, 30 A Common-Cathode Diode

### Product Summary

$I_{F(AVG)}$ per diode	15	A
$V_{RRM}$	200	V
$Q_{RR}$ (Typ at 125 °C)	55.4	nC
$I_{RRM}$ (Typ at 125 °C)	3.5	A
Softness $t_b/t_a$ (Typ at 125 °C)	0.31	

### Pin Assignment



### RoHS Compliant

Package uses Lead-free plating and "Green" mold compound Halogen free per IEC 61249-2-21.

### Absolute Maximum Ratings

Absolute maximum ratings are the values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Symbol	Parameter	Conditions	Rating	Units
$V_{RRM}$	Peak repetitive reverse voltage	$T_J = 25\text{ °C}$	200	V
$I_{F(AVG)}$	Average forward current	Per Diode, $T_J = 150\text{ °C}$ , $T_C = 120\text{ °C}$ Per Device, $T_J = 150\text{ °C}$ , $T_C = 120\text{ °C}$	15 30	A
$I_{FSM}$	Non-repetitive peak surge current	Per Diode, 60 Hz, 1/2 cycle	130	A
$I_{FSM}$	Non-repetitive peak surge current	Per Diode, 1/2 cycle of $t = 28\text{ }\mu\text{s}$ Sinusoid, $T_C = 25\text{ °C}$	350	A
$T_J$	Operating junction temperature range		-55 to 150	°C
$T_{STG}$	Storage temperature		-55 to 150	°C
	Lead soldering temperature	Leads at 1.6 mm from case, 10 sec	300	°C
$P_D$	Power dissipation	$T_C = 25\text{ °C}$	56.8	W

### Thermal Resistance

Symbol	Resistance from:	Conditions	Rating	Units
$R_{\theta JA}$	Junction to ambient	TO-220AB (only)	62	°C/W
$R_{\theta JC}$	Junction to case	Per Diode	2.2	°C/W
		Per Device	1.1	°C/W

### General Description

This device has the lowest  $Q_{RR}$  of any 200 V Silicon diode. Its recovery characteristics increase efficiency, reduce EMI and eliminate snubbers.

### Applications

- AC/DC and DC/DC output rectification
  - Output and freewheeling diodes
- Motor drive circuits
- DC-AC inverters

### Features

- Low  $Q_{RR}$ , Low  $I_{RRM}$ , Low  $t_{RR}$
- High  $di_F/dt$  capable (1000A/ $\mu\text{s}$ )
- Soft recovery

### Benefits

- Increases efficiency
  - Eliminates need for snubber circuits
  - Reduces EMI filter component size and count
- Enables extremely fast switching

**Electrical Specifications at  $T_J = 25\text{ }^\circ\text{C}$  (unless otherwise specified)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>DC Characteristics per diode</b>							
$I_R$	Reverse current per diode	$V_R = 200\text{ V}, T_J = 25\text{ }^\circ\text{C}$	-	-	500	$\mu\text{A}$	
		$V_R = 200\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	0.6	-	mA	
$V_F$	Forward voltage per diode	$I_F = 15\text{ A}, T_J = 25\text{ }^\circ\text{C}$	-	0.98	1.2	V	
		$I_F = 15\text{ A}, T_J = 150\text{ }^\circ\text{C}$	-	0.86	-	V	
$C_J$	Junction capacitance per diode	$V_R = 10\text{ V}, 1\text{ MHz}$	-	54	-	pF	
<b>Dynamic Characteristics per diode</b>							
$t_{RR}$	Reverse recovery time, per diode	$di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 130\text{ V},$ $I_F = 15\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	-	16.5	-	ns
			$T_J = 125\text{ }^\circ\text{C}$	-	25.4	-	ns
$Q_{RR}$	Reverse recovery charge, per diode	$di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 130\text{ V},$ $I_F = 15\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	-	21.5	33	nC
			$T_J = 125\text{ }^\circ\text{C}$	-	55.4	-	nC
$I_{RRM}$	Maximum reverse recovery current, per diode	$di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 130\text{ V},$ $I_F = 15\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	-	2.1	3.1	A
			$T_J = 125\text{ }^\circ\text{C}$	-	3.5	-	A
S	Softness per diode = $\frac{t_b}{t_a}$	$di_F/dt = 200\text{ A}/\mu\text{s}$ $V_R = 130\text{ V},$ $I_F = 15\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	-	0.44	-	
			$T_J = 125\text{ }^\circ\text{C}$	-	0.31	-	

**Note to component engineers:** Q-Series diodes employ Schottky technologies in their design and construction. Therefore, component engineers should plan their test setups to be similar to traditional Schottky test setups. (For further details, see application note AN-300.)

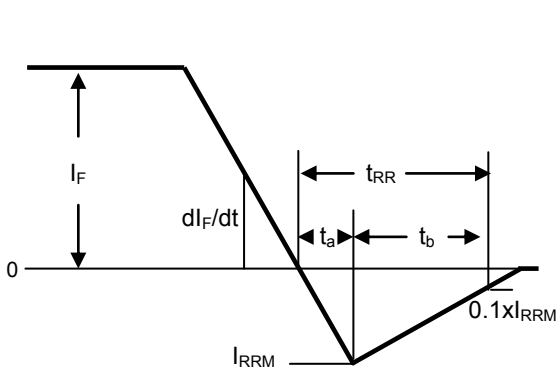


Figure 1. Reverse Recovery Definitions

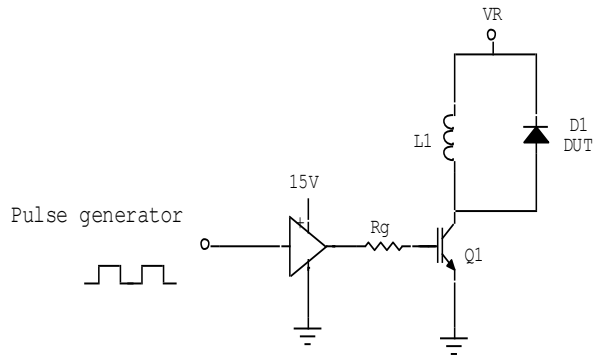


Figure 2. Reverse Recovery Test Circuit

Electrical Specifications at  $T_J = 25\text{ }^\circ\text{C}$  (unless otherwise specified)

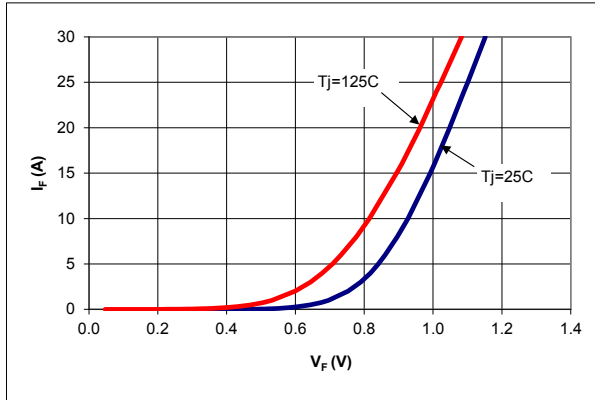


Figure 3. Typical  $I_F$  vs  $V_F$

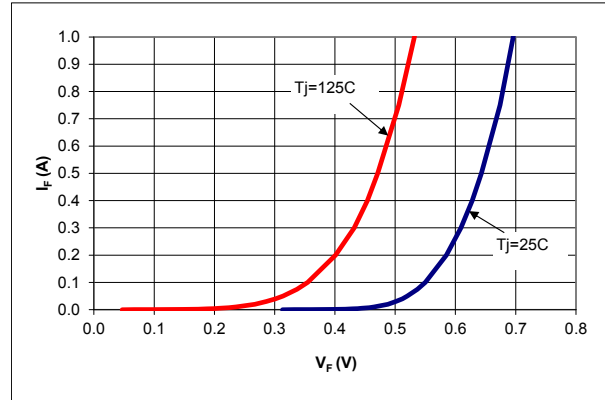


Figure 4. Typical  $I_F$  vs  $V_F$

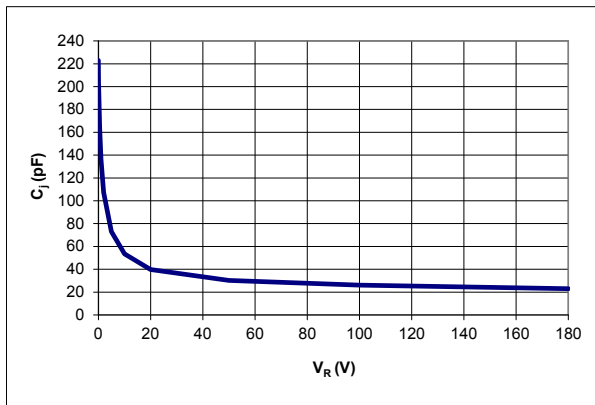


Figure 5. Typical  $C_i$  vs  $V_R$

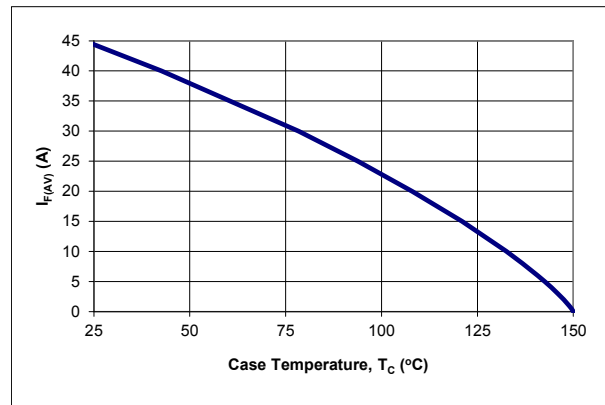


Figure 6. DC Current Derating Curve

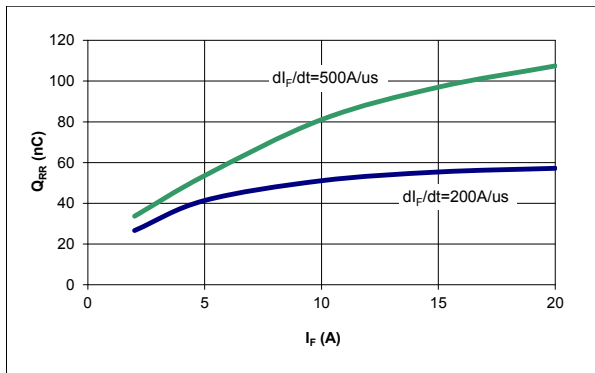


Figure 7. Typical  $Q_{RR}$  vs  $I_F$  at  $T_J=125\text{ }^\circ\text{C}$

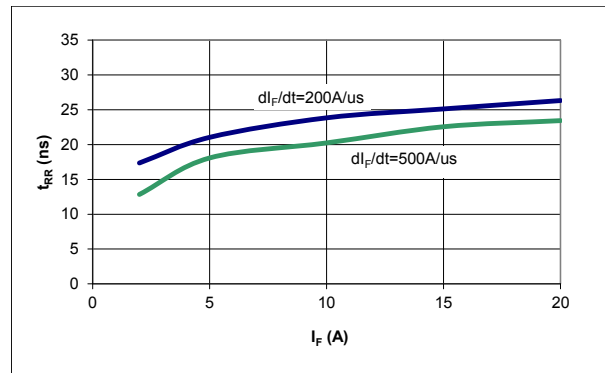


Figure 8. Typical  $t_{RR}$  vs  $I_F$  at  $T_J=125\text{ }^\circ\text{C}$

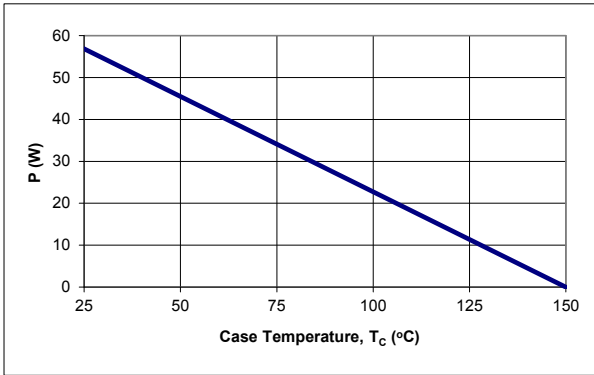


Figure 9. Power Derating Curve

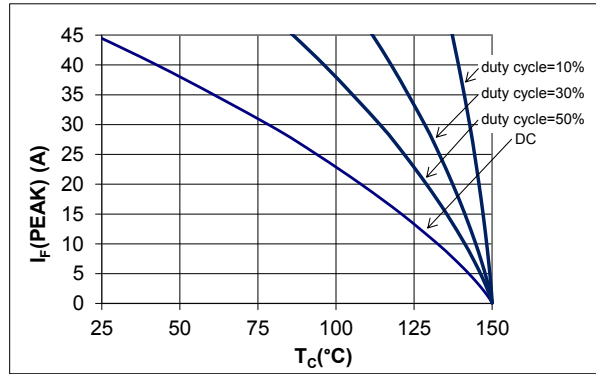


Figure 10. IF (Peak) vs TC, f = 70 kHz

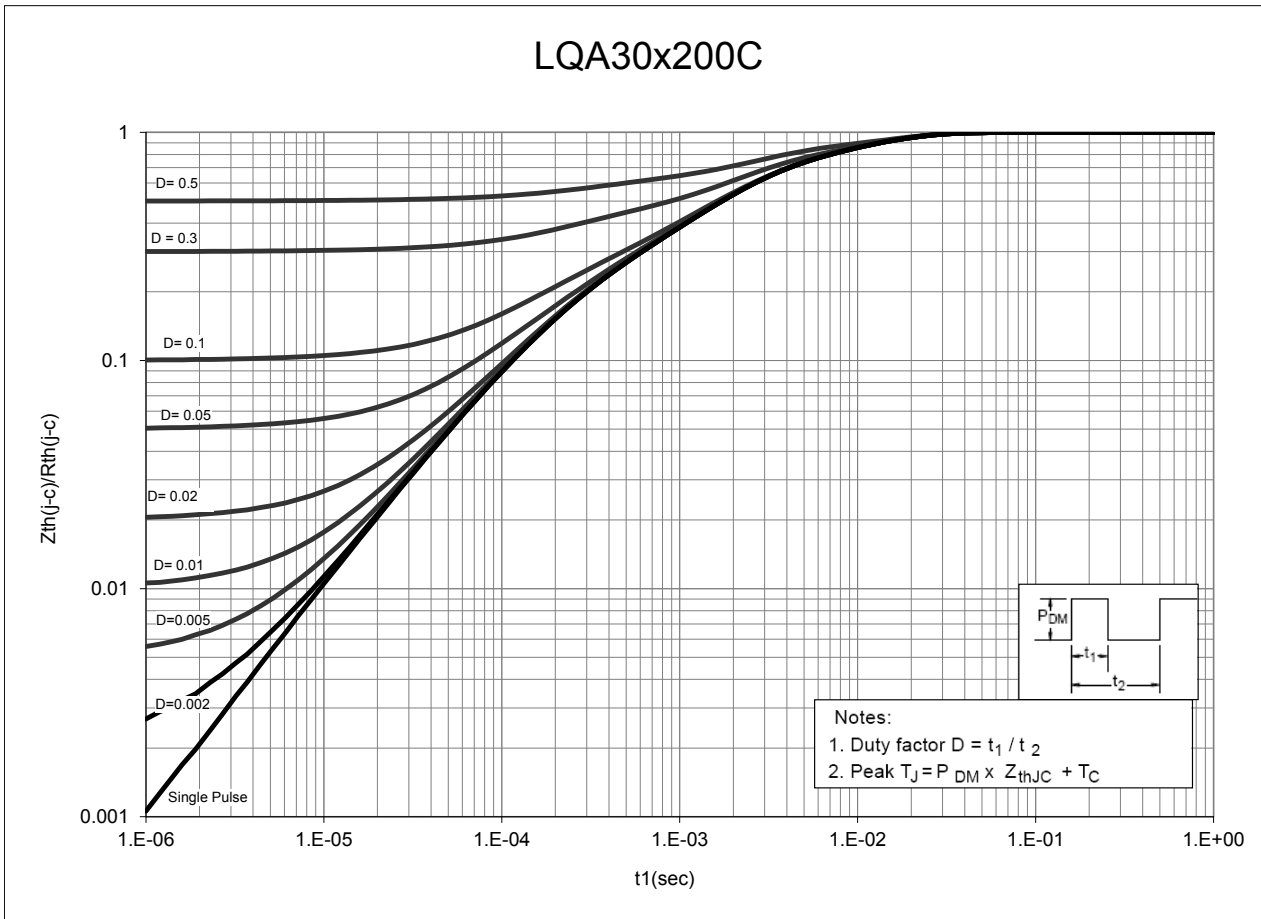
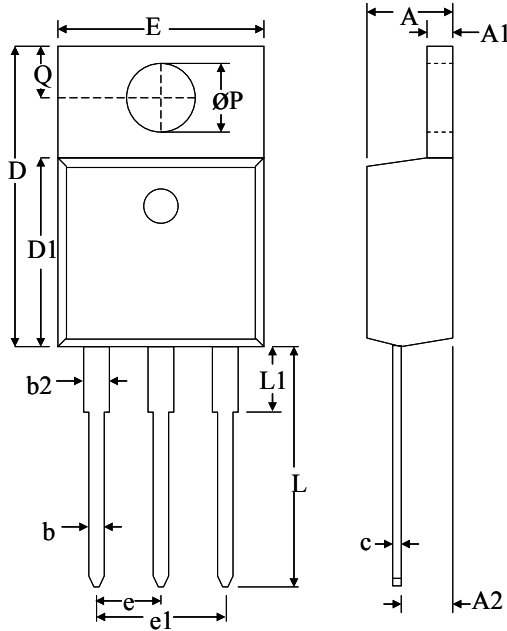


Figure 11. Normalized Maximum Transient Thermal Impedance

## Dimensional Outline Drawings

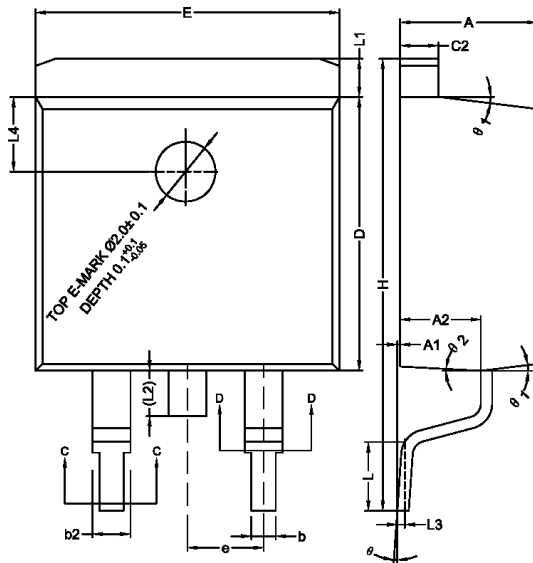
TO-220AB



Dim	Millimeters	
	MIN	MAX
A	4.32	4.70
A1	1.11	1.38
A2	2.59	2.79
b	0.77	1.00
b2	1.23	1.36
C	0.34	0.47
D	14.71	15.75
D1	9.05	9.25
E	9.96	10.36
e	2.44	2.64
e1	4.98	5.18
L	12.70	14.22
L1	–	3.90
ØP	3.71	3.96
Q	2.54	2.90

Mechanical Mounting Method	Maximum Torque / Pressure specification
Screw through hole in package tab	1 Newton Meter (nm) or 8.8 inch-pounds (lb-in)
Clamp against package body	12.3 kilogram-force per square centimeter (kgf/cm <sup>2</sup> ) or 175 lbf/in <sup>2</sup>

TO-263AB



Dim	Millimeters	
	MIN	MAX
A	4.40	4.70
A1	0.00	0.25
A2	2.59	2.79
b	0.77	0.90
b2	1.23	1.36
c2	1.22	1.32
D	9.05	9.25
E	10.06	10.26
e	2.54 BSC	2.54 BSC
H	14.70	15.50
L	2.00	2.60
L1	1.17	1.40
L2	–	1.75
L3	0.25 BSC	0.25 BSC
L4	2.00 BSC	2.00 BSC
Ø	0°	8°
Ø1	5°	9°
Ø2	1°	5°

**Soldering time and temperature:** This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

## Ordering Information

Part Number	Package	Packing
LQA30T300C	TO-220AB	50 units/tube
LQA30B300C	TO-263AB	800 units/reel

The information contained in this document is subject to change without notice

---

Revision	Notes	Date
1.0	Initial Release	04/13

## For the latest updates, visit our website: [www.powerint.com](http://www.powerint.com)

Power Integrations reserves the right to make changes to its products at any time to improve reliability or manufacturability. Power Integrations does not assume any liability arising from the use of any device or circuit described herein. POWER INTEGRATIONS MAKES NO WARRANTY HEREIN AND SPECIFICALLY DISCLAIMS ALL WARRANTIES INCLUDING, WITHOUT LIMITATION, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF THIRD PARTY RIGHTS.

### PATENT INFORMATION

The products and applications illustrated herein (including transformer construction and circuits' external to the products) may be covered by one or more U.S. and foreign patents, or potentially by pending U.S. and foreign patent applications assigned to Power Integrations. A complete list of Power Integrations' patents may be found at [www.powerint.com](http://www.powerint.com). Power Integrations grants its customers a license under certain patent rights as set forth at <http://www.powerint.com/ip.htm>.

The PI Logo, TOPSwitch, TinySwitch, LinkSwitch, LYTSwitch, DPA-Switch, PeakSwitch, CAPZero, SENZero, LinkZero, HiperPFS, HiperTFS, HiperLCS, Qspeed, EcoSmart, Clampless, E-Shield, Filterfuse, StackFET, PI Expert and PI FACTS are trademarks of Power Integrations, Inc. Other trademarks are property of their respective companies. ©Copyright 2013 Power Integrations, Inc.

## Power Integrations Worldwide Sales Support Locations

### WORLD HEADQUARTERS

5245 Hellyer Avenue  
San Jose, CA 95138, USA.  
Main: +1-408-414-9200  
Customer Service:  
Phone: +1-408-414-9665  
Fax: +1-408-414-9765  
e-mail: [usasales@powerint.com](mailto:usasales@powerint.com)

### GERMANY

Lindwurmstrasse 114  
80337, Munich  
Germany  
Phone: +49-895-527-39110  
Fax: +49-895-527-39200  
e-mail: [eurosales@powerint.com](mailto:eurosales@powerint.com)

### JAPAN

Kosei Dai-3 Building  
2-12-11, Shin-Yokohama,  
Kanagawa 222-0033  
Japan  
Phone: +81-45-471-1021  
Fax: +81-45-471-3717  
e-mail: [japansales@powerint.com](mailto:japansales@powerint.com)

### TAIWAN

5F, No. 318, Nei Hu Rd.,  
Sec. 1  
Nei Hu District  
Taipei 11493, Taiwan R.O.C.  
Phone: +886-2-2659-4570  
Fax: +886-2-2659-4550  
e-mail: [taiwansales@powerint.com](mailto:taiwansales@powerint.com)

### CHINA (SHANGHAI)

Rm 1601/1610, Tower 1,  
Kerry Everbright City  
No. 218 Tianmu Road West,  
Shanghai, P.R.C. 200070  
Phone: +86-21-6354-6323  
Fax: +86-21-6354-6325  
e-mail: [chinasales@powerint.com](mailto:chinasales@powerint.com)

### INDIA

#1, 14<sup>th</sup> Main Road  
Vasanthanagar  
Bangalore-560052  
India  
Phone: +91-80-4113-8020  
Fax: +91-80-4113-8023  
e-mail: [indiasales@powerint.com](mailto:indiasales@powerint.com)

### KOREA

RM 602, 6FL  
Korea City Air Terminal B/D,  
159-6  
Samsung-Dong, Kangnam-Gu,  
Seoul, 135-728 Korea  
Phone: +82-2-2016-6610  
Fax: +82-2-2016-6630  
e-mail: [koreasales@powerint.com](mailto:koreasales@powerint.com)

### EUROPE HQ

1st Floor, St. James's House  
East Street, Farnham  
Surrey GU9 7TJ  
United Kingdom  
Phone: +44 (0) 1252-730-141  
Fax: +44 (0) 1252-727-689  
e-mail: [eurosales@powerint.com](mailto:eurosales@powerint.com)

### CHINA (SHENZHEN)

3rd Floor, Block A,  
Zhongtong International Business  
Center, No. 1061, Xiang Mei Rd,  
FuTian District, ShenZhen,  
China, 518040  
Phone: +86-755-8379-3243  
Fax: +86-755-8379-5828  
e-mail: [chinasales@powerint.com](mailto:chinasales@powerint.com)

### ITALY

Via Milanese 20, 3<sup>rd</sup> Fl.  
20099 Sesto San Giovanni  
(MI) Italy  
Phone: +39-024-550-8701  
Fax: +39-028-928-6009  
e-mail: [eurosales@powerint.com](mailto:eurosales@powerint.com)

### SINGAPORE

51 Newton Road,  
#19-01/05 Goldhill Plaza  
Singapore, 308900  
Phone: +65-6358-2160  
Fax: +65-6358-2015  
e-mail: [singaporesales@powerint.com](mailto:singaporesales@powerint.com)

### APPLICATIONS HOTLINE

World Wide +1-408-414-9660

### APPLICATIONS FAX

World Wide +1-408-414-9760

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

 [View LQA30B200C](#) on WIN SOURCE

 [Power Integrations](#) Information

## Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management